

AM80814-025

PRELIMINARY DATA

RF & MICROWAVE TRANSISTORS L-BAND RADAR APPLICATIONS

REFRACTORY/GOLD METALLIZATION

- EMITTER SITE BALLASTED
- LOW THERMAL RESISTANCE
- INPUT/OUTPUT MATCHING
- OVERLAY GEOMETRY
- METAL/CERAMIC HERMETIC PACKAGE
- $P_{OUT} = 25$ W MIN. WITH 7.0 dB GAIN



AM80814-025

BRANDING 80814-25

DESCRIPTION

AM80814-025 is a high power silicon Class C transistor designed for ultra-broadband L-Band radar applications.

This device is capable of operation over a broad range of pulse widths and duty cycles. Low RF thermal resistance and computerized automatic wire bonding techniques ensure high reliability and product consistency.

AM80814-025 is supplied in the industry-standard AMPAC[™] hermetic Metal/Ceramic package incorporating Input/Output impedance matching.



ABSOLUTE MAXIMUM RATINGS (Tcase	e = 25°C)
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Symbol	Parameter	Value	Unit
P _{DISS}	Power Dissipation*($T_C \le 75^{\circ}C$)	75	W
Ι _C	Device Current*	3.5	А
V _{CC}	Collector-Supply Voltage*	38	V
TJ	Junction Temperature (Pulsed RF Operation)	250	°C
T _{STG}	Storage Temperature	– 65 to +200	°C

THERMAL DATA

RTH(j-c)Junction-Case Thermal Resistance*2.3°C/W
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*Applies only to rated RF amplifier operation

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ELECTRICAL SPECIFICATIONS ($T_{case} = 25^{\circ}C$)

STATIC

			Value			
Symbol		Test Conditions	Min.	Тур.	Max.	Unit
ВVсво	$I_C = 10 mA$	$I_E = 0mA$	55	—	—	V
BVEBO	$I_E = 1 m A$	$I_{C} = 0mA$	3.5	_		V
BVCER	IC = 20mA	$R_{BE} = 10\Omega$	55	_		V
ICES	$V_{\text{BE}} = 0V$	$V_{CE} = 28V$	—	_	5	mA
h _{FE}	$V_{CE} = 5V$	$I_{C} = 1A$	15	_	150	_

DYNAMIC

				Value			
Symbol	Test Conditions				Тур.	Max.	Unit
Pout	f = 850 — 1400MHz	$P_{\text{IN}}=5.0W$	$V_{CC} = 35V$	25	—		W
ηc	f = 850 — 1400MHz	$P_{\text{IN}}=5.0W$	$V_{CC} = 35V$	38	—		%
GP	f = 850 — 1400MHz	$P_{\text{IN}}=5.0W$	$V_{CC}=35V$	7.0			dB

Note: Pulse Width = 120μ S Duty Cycle = 4%

PACKAGE MECHANICAL DATA





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